

## 阅读申明

- 1.本站收集的数据手册和产品资料都来自互联网，版权归原作者所有。如读者和版权方有任何异议请及时告之，我们将妥善解决。
- 2.本站提供的中文数据手册是英文数据手册的中文翻译，其目的是协助用户阅读，该译文无法自动跟随原稿更新，同时也可能存在翻译上的不当。建议读者以英文原稿为参考以便获得更精准的信息。
- 3.本站提供的产品资料，来自厂商的技术支持或者使用者的心得体会等，其内容可能存在描述上的差异，建议读者做出适当判断。
- 4.如需与我们联系，请发邮件到marketing@iczoom.com，主题请标有“数据手册”字样。

## Read Statement

1. The datasheets and other product information on the site are all from network reference or other public materials, and the copyright belongs to the original author and original published source. If readers and copyright owners have any objections, please contact us and we will deal with it in a timely manner.
2. The Chinese datasheets provided on the website is a Chinese translation of the English datasheets. Its purpose is for reader's learning exchange only and do not involve commercial purposes. The translation cannot be automatically updated with the original manuscript, and there may also be improper translations. Readers are advised to use the English manuscript as a reference for more accurate information.
3. All product information provided on the website refer to solutions from manufacturers' technical support or users the contents may have differences in description, and readers are advised to take the original article as the standard.
4. If you have any questions, please contact us at marketing@iczoom.com and mark the subject with "Datasheets" .

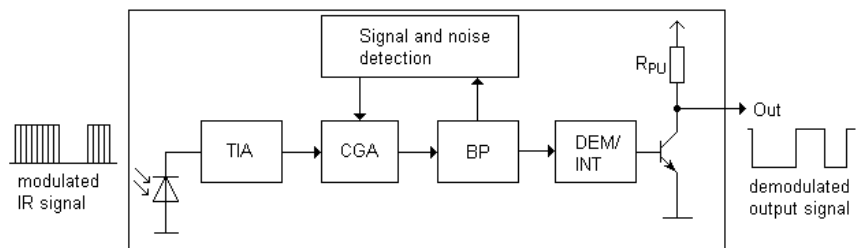
### Infrared Receiver Control Receiver Module IRM-V5XXT/TR1 Series



Pin Configuration

1. OUT
2. Vcc
3. GND

#### Block Diagram



#### Features

- High shielding against electric field disturbance.
- Circular lens to improve the receive characteristic.
- Line-up for various center carrier frequencies.
- Low voltage and low power consumption.
- High immunity against ambient light.
- Photodiode with integrated circuit.
- TTL and CMOS compatibility.
- Side-received SMD.
- Suitable burst length 10 pulses/burst.
- This product itself will remain within RoHS compliant version.
- Pb free.

#### Descriptions

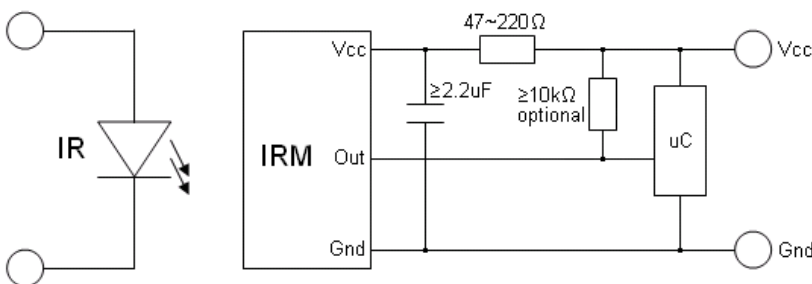
The device is miniature SMD type infrared receiver that has been developed and designed by utilizing the latest IC technology.

The PIN diode and preamplifier are assembled onto a lead frame and molded into an epoxy package which operates as an IR filter. The demodulated output signal can directly be decoded by a microprocessor

## Applications

- Light detecting portion of remote control
- AV instruments such as Audio, TV, VCR, CD, MD, etc
- Home appliances such as Air-conditioner, Fan, etc
- Other devices using IR remote control
- CATV set top boxes
- Multi-media Equipment

## Application Circuit



## Parts Table

| Model No.     | Carrier Frequency |
|---------------|-------------------|
| IRM-V538T/TR1 | 38 kHz            |

## Absolute Maximum Ratings (T<sub>a</sub>=25°C)

| Parameter                         | Symbol | Rating    | Unit |
|-----------------------------------|--------|-----------|------|
| Supply Voltage                    | Vcc    | 0~6       | V    |
| Operating Temperature             | Topr   | -20 ~ +80 |      |
| Storage Temperature <sup>*1</sup> | Tstg   | -40 ~ +85 |      |

<sup>\*1</sup> 4mm from mold body less than 5 seconds

**Electro-Optical Characteristics (Ta=25 and Vcc=3.0V)**

| Parameter                 | Symbol          | MIN. | TYP. | MAX. | Unit    | Condition             |
|---------------------------|-----------------|------|------|------|---------|-----------------------|
| Current Consumption       | I <sub>cc</sub> | -    | -    | 1.2  | mA      | No signal input       |
| Supply Voltage            | V <sub>cc</sub> | 2.7  | -    | 5.5  | V       |                       |
| Peak Wavelength           | $\lambda_p$     | -    | 940  | -    | nm      |                       |
| Reception Distance        | L <sub>0</sub>  | 8    | -    | -    | m       |                       |
|                           | L <sub>45</sub> | 5    | -    | -    |         |                       |
| Half Angle(Horizontal)    | $\Theta_h$      | ---  | 45   | ---  | deg     | At the ray axis<br>*1 |
| Half Angle(Vertical)      | $\Theta_v$      | ---  | 45   | ---  | deg     |                       |
| High Level Pulse Width    | T <sub>WH</sub> | 400  | -    | 800  | $\mu$ s | At the ray axis<br>*2 |
| Low Level Pulse Width     | T <sub>WL</sub> | 400  | -    | 800  | $\mu$ s |                       |
| High Level Output Voltage | V <sub>H</sub>  | 2.7  | -    | -    | V       |                       |
| Low Level Output Voltage  | V <sub>L</sub>  | -    | 0.2  | 0.5  | V       |                       |

**Notes:**

\*1 : The ray receiving surface at a vertex and relation to the ray axis in the range of  $\theta=0^\circ$  and  $\theta=45^\circ$ .

\*2 : A range from 30cm to the arrival distance. Average value of 50 pulses.

## Test Method

The specified electro-optical characteristic is satisfied under the following Conditions:

1. Measurement environment  
A place without extreme light reflected
2. External light  
Ordinary white fluorescent lamps (Light source temperature 2856°K,  $E_e = 10\text{Lux}$ ) without high frequency modulation
3. Standard transmitter  
The test transmitter is calibrated by using the circuit shown in figure 2. The radiation intensity of the transmitter is adjusted until  $V_o=400\text{mVp-p}$ . Both, the test transmitter and the photo diode, have a peak wavelength of 940nm. The photo diode for calibration is PD438B ( $\lambda_p=940\text{nm}$ ,  $V_r=5\text{V}$ ).
4. Measuring system According to the measuring system shown in Fig.-3

Fig.-1 Transmitter Wave Form

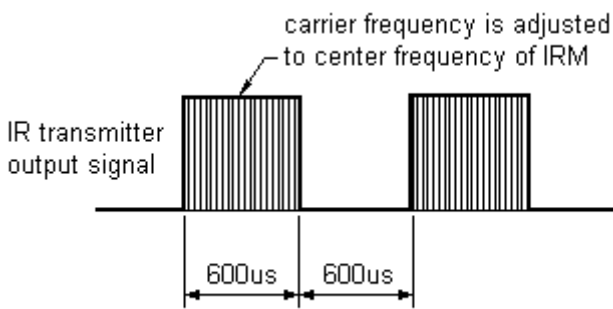
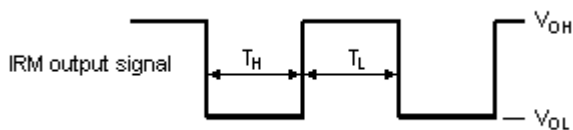


Fig.-2 Measuring Method



D.U.T output Pulse

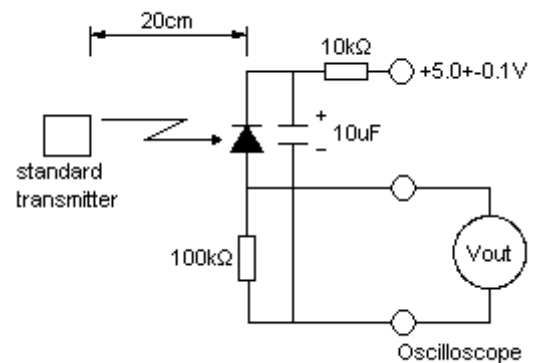
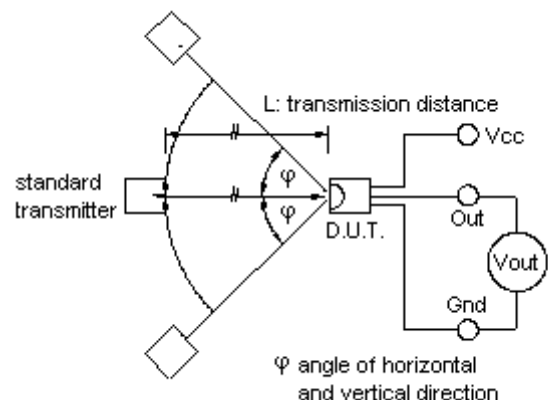


Fig.-3 Measuring System



Typical Performance Curves

Fig.-4 Relative Spectral Sensitivity vs. Wavelength

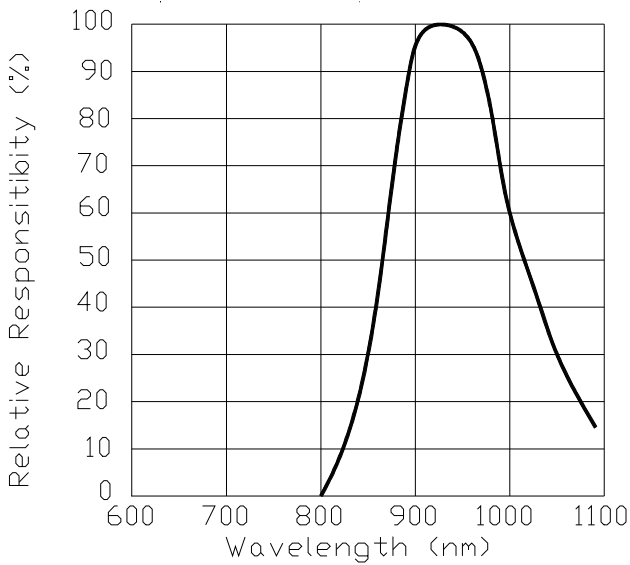


Fig.-5 Relative Transmission Distance vs. Direction

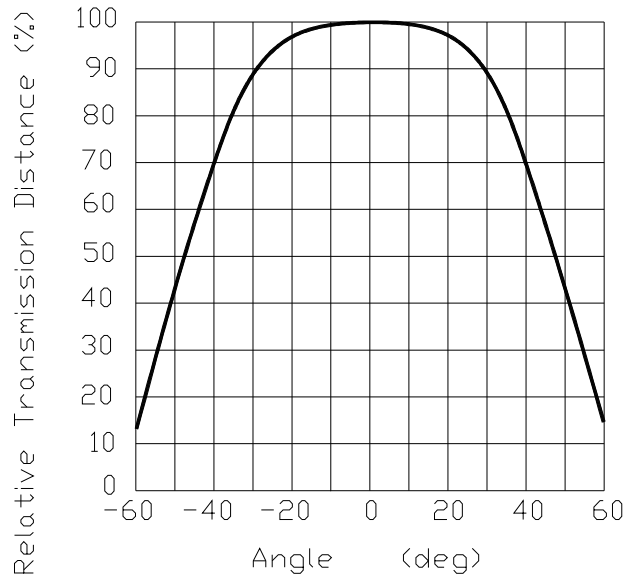


Fig.-6 Output Pulse Length vs. Arrival Distance

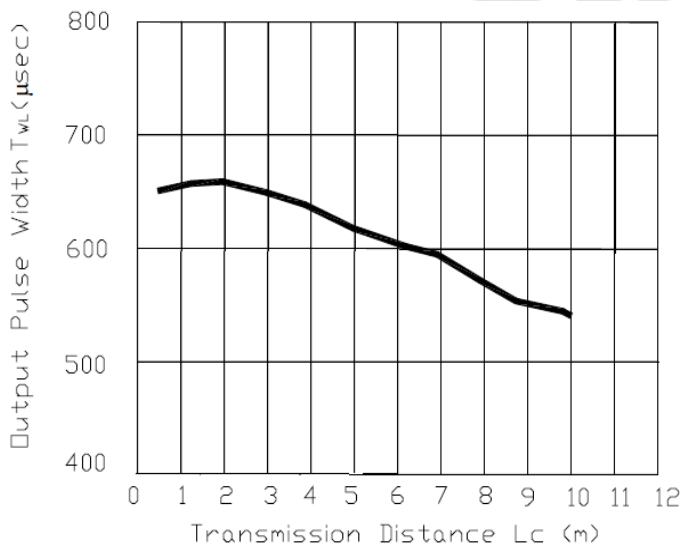


Fig.-7 Arrival Distance vs. Supply Voltage

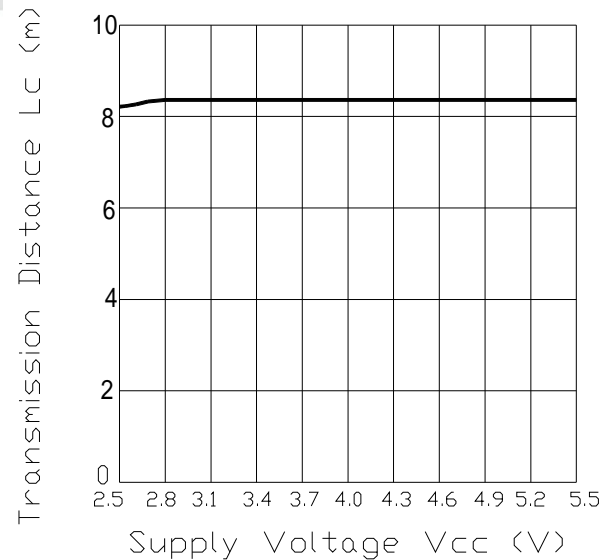
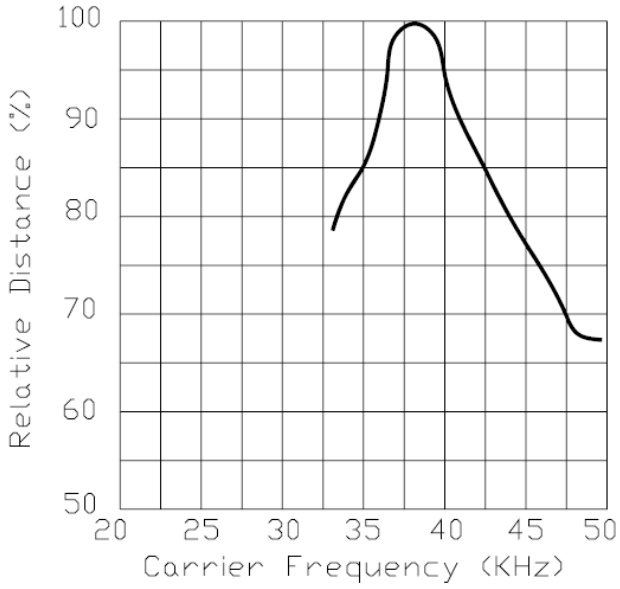


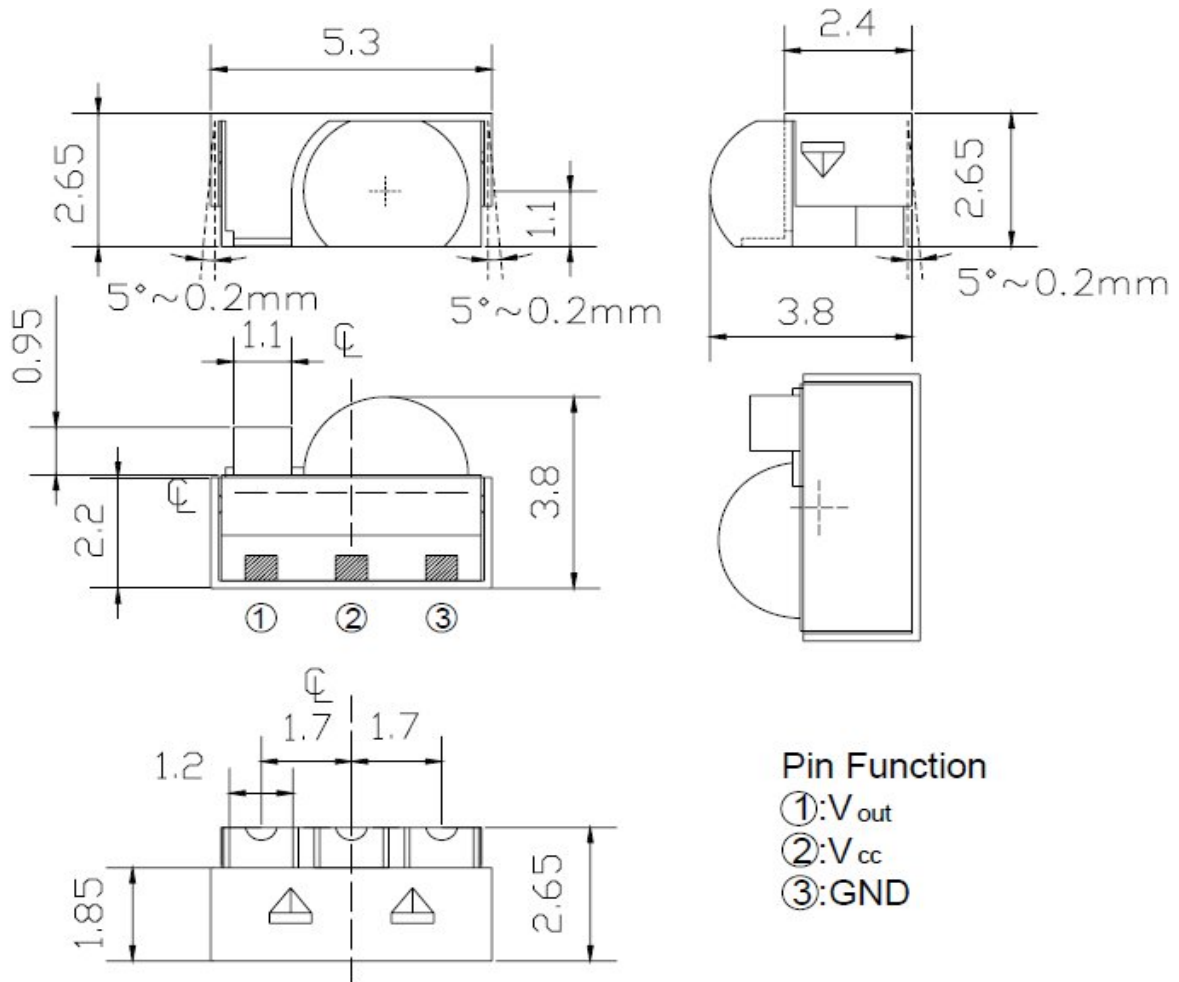
Fig.-8 Relative Transmission Distance vs. Center Carrier Frequency



EVERLIGHT

### Package Dimensions

(Dimensions in mm)

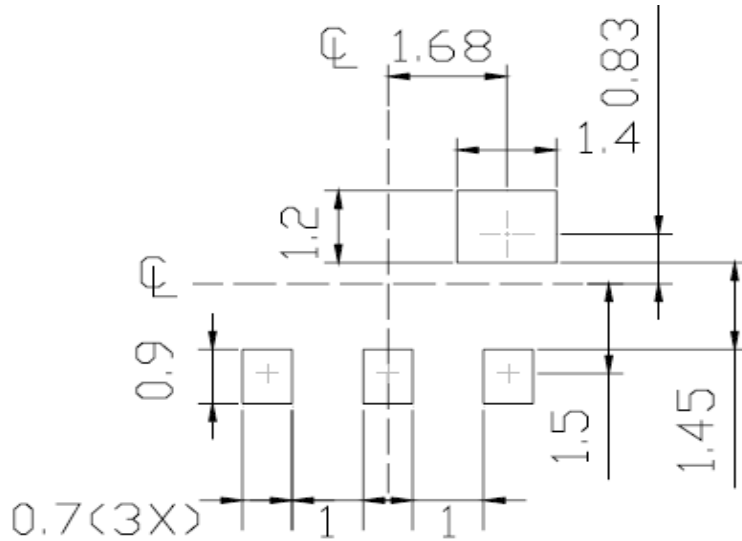


- Notes :** 1.All dimensions are in millimeters.  
2.Tolerances unless dimensions  $\pm 0.3$ mm.



## Soldering patterns

The following soldering patterns are recommended for reflow-soldering

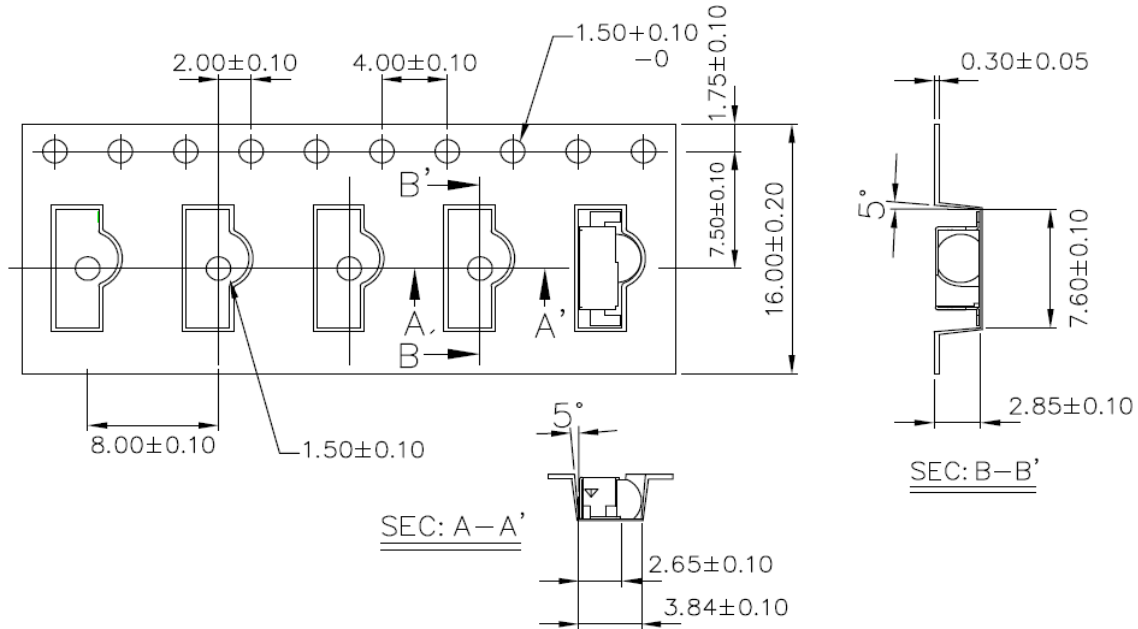


Unit: mm

## Code information

| Protocol   | Suitable | Protocol        | Suitable |
|------------|----------|-----------------|----------|
| JVC        | No       | RCA             | No       |
| Matsushita | Yes      | Sharp           | Yes      |
| Mitsubishi | No       | Sony 12 Bit     | Yes      |
| NEC        | Yes      | Sony 15 Bit     | No       |
| RC5        | Yes      | Sony 20 Bit     | No       |
| RC6        | Yes      | Toshiba         | Yes      |
| RCMM       | No       | Zenith          | Yes      |
| RCS-80     | No       | Continuous Code | No       |

Tape & Reel Packing Specifications

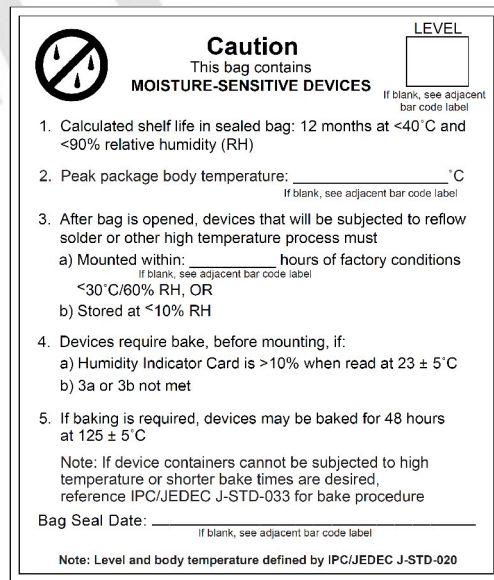
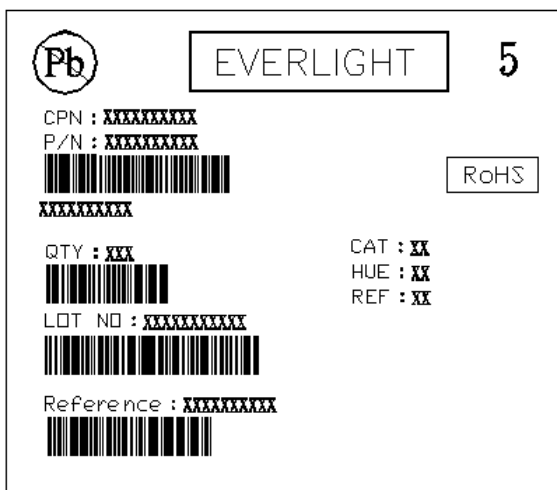


Packing Quantity

2000 pcs / Reel

5 Reels / Carto

Label format



Moisture Classification-storage and used condition label

## Recommended method of storage

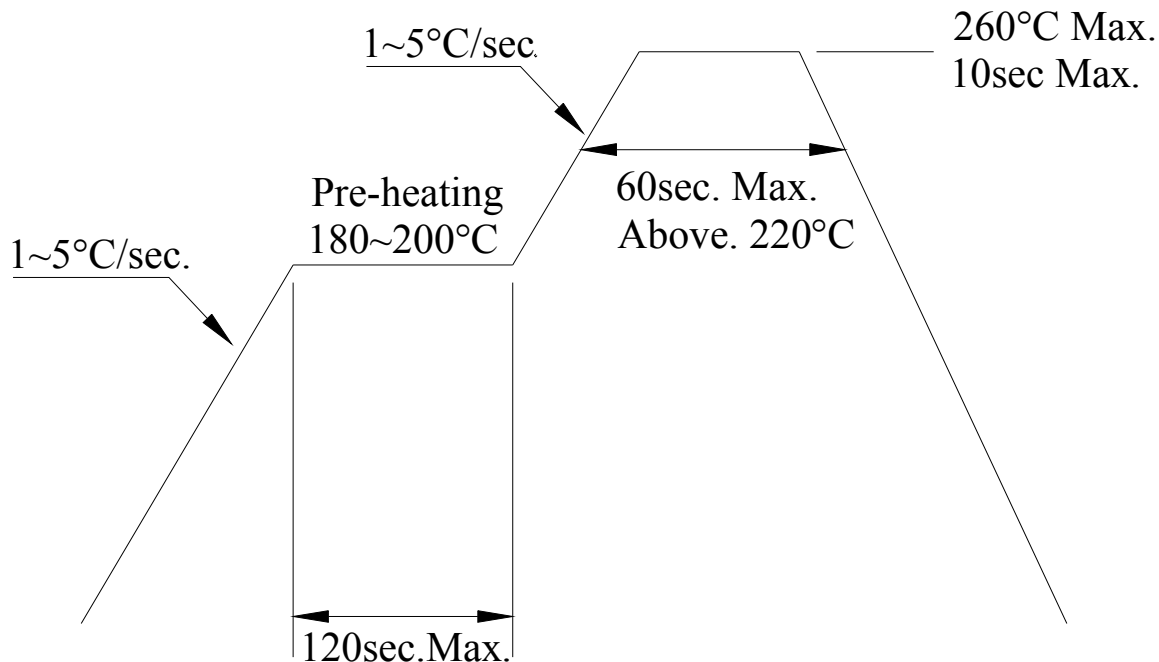
The following are general recommendations for moisture sensitive level (MSL) 4 storage and use:

1. Shelf life in sealed bag from the bag seal date: 12 months at  $< 40\text{ }^{\circ}\text{C}$  and  $< 90\%$  relative humidity (RH)
2. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must mounted within 72 hours of factory conditions  $< 30\text{ }^{\circ}\text{C}/60\%\text{RH}$ .
3. If the moisture absorbent material (silica gel) has faded away or the IRM has exceeded the storage time. Baking treatment is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the conditions:  $60\pm 5\text{ }^{\circ}\text{C}$  for 96 hours.

## ESD Precaution

Proper storage and handing procedures should be followed to prevent ESD damage to the devices especially when they are removed from the Anti-static bag. Electro-Static Sensitive Devices warning labels are on the packing.

## Solder Reflow Temperature Profile



Note:

1. Reflow soldering should not be done more than two times.
2. When soldering, do not put stress on the IRM device during heating.
3. After soldering, do not warp the circuit board.

## DISCLAIMER

1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
3. These specification sheets include materials protected under copyright of EVERLIGHT. Reproduction in any form is prohibited without the specific consent of EVERLIGHT.

EVERLIGHT